

## Solder-in breadboard 2x2" 2.00mm pitch plated holes

### Product Highlights

Plated through hole solder breadboard  
Immersion Gold (ENIG) Finish  
Double Sided  
600 pads in total  
Plated through hole pads on 2.00mm matrix  
Hole pitch of 2.00mm center-to-center  
24 rows, 25 columns

### Specifications

Dimensions:	2.0" x 2.0" x 0.0625"
PCB construction:	FR-4 UL94V-0
PCB operating temperature range:	-40°C to +130°C
PCB reflow maximum temperature:	+260°C
Pad size:	Round: 1.5mm (0.059") diameter
Pad pitch:	2.00mm center-to-center
Space between pads:	0.50mm (0.020")
Holes:	1.00mm (0.039") in diameter

